

LM48861

March 16, 2010

Boomer® Audio Power Amplifier Series

Ground-Referenced, Ultra Low Noise, Stereo Headphone Amplifier

General Description

The LM48861 is a single supply, ground-referenced stereo headphone amplifier. Part of National's PowerWise® product family, the LM48861 consumes only 3mW of power, yet still provides great audio performance. The ground-referenced architecture eliminates the larger DC blocking capacitors required by traditional headphone amplifier's saving board space and reducing cost.

The LM48861 features common-mode sensing that corrects for any differences between the amplifier ground and the potential at the headphone return terminal, minimizing noise created by any ground mismatches.

The LM48861 delivers 22mW/channel into a 32Ω load with <1% THD+N with a 1.8V supply. Power supply requirements allow operation from 1.2V to 2.8V. High power supply rejection ratio (PSRR), 83dB at 217Hz, allows the device to operate in noisy environments without additional power supply conditioning. A low power shutdown mode reduces supply current consumption to $0.01\mu A$.

Superior click and pop suppression eliminates audible transients on power-up/down and during shutdown. The LM48861 is available in an ultra-small 12-bump, 0.4mm pitch, micro SMD package (1.215mm x 1.615mm).

Key Specifications

Output Power/channel at V_{DD} = 1.5V, THD+N = 1%

> $R_L = 16\Omega$ 12mW (typ) $R_L = 32\Omega$ 13mW (typ)

Output Power/channel at V_{DD} = 1.8V, THD+N = 1%

> $R_L = 16\Omega$ 24mW (typ) $R_1 = 32\Omega$ 22mW (typ)

Quiescent Power Supply Current

at 1.5V 2mA (typ)

■ PSRR at 217Hz 83dB (typ)

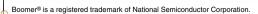
■ Shutdown Current 0.01µA (typ)

Features

- Ground referenced outputs eliminates output coupling capacitors
- Common-mode sensing
- Advanced click-and-pop suppression
- Low supply current
- Minimum external components
- Micro-power shutdown
- ESD protection of 8kV HBM contact
- Available in space-saving 12-bump microSMD package

Applications

- Mobile Phones
- Portable electronic devices
- MP3 Players



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Typical Application 查询"LM48861"供应商

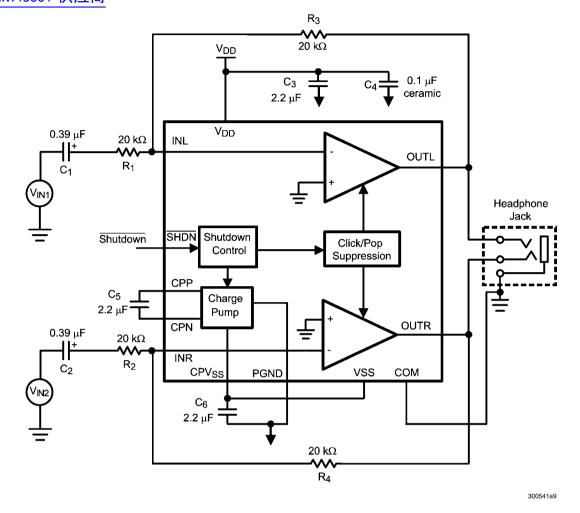
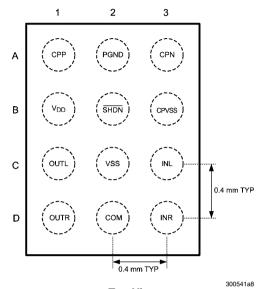


FIGURE 1. Typical Audio Amplifier Application Circuit

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TM Package 1.215mm x 1.615mm x 0.6mm



Top View Order Number LM48861TM See NS Package Number TMD12AAA

XVG K3

Top View
X = Date code
V = Lot traceability
G = Boomer
K3 = LM48861TM

300541h5

Ordering Information

Order Number	Package	Package DWG #	Transport Media	MSL Level	Green Status
LM48861TM	12 Bump microSMD 0.4mm Pitch	TMD12AAA	250 and 3000 units on tape and reel	1	RoHS/no Sb/Br

Bump Description

Bump	Name	Description		
A1	CPP	Charge Pump Flying Capacitor Positive Terminal		
A2	PGND	Power Ground		
A3	CPN	Charge Pump Flying Capacitor Negative Terminal		
B1	V _{DD}	Positive Power Supply		
B2	SHDN	Active Low Shutdown		
В3	CPV _{SS}	Charge Pump Output		
C1	OUTL	Left Channel Output		
C2	V _{SS}	Negative Power Supply		
C3	INL	Left Channel Input		
D1	OUTR	Right Channel Output		
D2	COM	Ground reference for inputs and HP		
D3	INR	Right Channel Input		

Absolute Maximum Ratings (Note 1, Note 道演"LM48861"供应商

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (Note1) 3VStorage Temperature -65°C to $+150^{\circ}\text{C}$ Input Voltage -0.3V to $V_{DD} + 0.3V$ Power Dissipation (*Note 3*) Internally Limited ESD Ratings (HBM) (*Note 4*) 2000VESD Ratings 8000V

(OUTL, OUTR) (Note 4)

ESD Susceptibility
(Machine Model) (Note 5)

Junction Temperature

Thermal Resistance θ_{JA} (TM)

200V

150°C

70°C/W (typ)

Operating Ratings

Temperature Range

 $T_{MIN} \le T_A \le T_{MAX}$ $-40^{\circ}C \le T_A \le +85^{\circ}C$ Supply Voltage (V_{DD}) $1.2V \le V_{DD} \le 2.8V$

Electrical Characteristics V_{DD} = 1.5V (Note 1, Note 2)

The following specifications apply for $V_{DD} = 1.5V$, $A_V = -1V/V$, $R_L = 32k\Omega$, f = 1kHz, unless otherwise specified. Limits apply for $T_A = 25^{\circ}C$.

	Parameter		LM48861		Unito
Symbol		Conditions	Typical (Note 6)	Limit (Note 7)	Units (Limits)
I _{DD}	Quiescent Power Supply Current	V _{IN} = 0V, Both channels enabled	2	2.8	mA (max)
I _{SD}	Shutdown Current	Shutdown Enabled V _{SHDN} = GND	0.01	1.5	μA (max)
V _{OS}	Output Offset Voltage	$V_{IN} = 0V$, $R_L = 32\Omega$ Both channels enabled	0.5	1.5	mV (max)
V _{IH}	Shutdown Input Voltage High			1.4	V(min)
V _{IL}	Shutdown Input Voltage Low			0.4	V(max)
T _{WU}	Wake Up Time		500	700	μs (max)
Po	Output Power	THD+N = 1% R_L = 32 Ω , f = 1kHz, Both channels in phase and active V_{DD} = 1.5V V_{DD} = 1.8V THD+N = 1% R_L = 16 Ω , f = 1kHz,	13 22	12 20	mW (min) mW (min)
		Both channels in phase and active $V_{DD} = 1.5V$ $V_{DD} = 1.8V$	12 24		mW mW
	Output Voltage to Line Out	$R_L = 10k\Omega$, $f = 1kHz$	 		-
$V_{LINE-OUT}$		$V_{DD} = 1.5V$, THD+N = 1%, $R_L = 10k\Omega$	1.1	1	V _{RMS} (min)
		$V_{DD} = 1.8V$, THD+N = 1%, $R_L = 10k\Omega$	1.3	1.2	V _{RMS} (min)
	Total Harmonic Distortion + Noise	$P_O = 8$ mW, $f = 1$ kHz, $R_L = 32\Omega$	0.04		%
THD+N		$P_O = 8$ mW, $f = 1$ kHz, $R_L = 16\Omega$	0.07		%
		$V_{OLIF} = 900 \text{mV}_{RMS}, f = 1 \text{kHz}, R_L = 10 \text{k}\Omega$	0.001		%
		$V_{RIPPLE} = 200 \text{mV}_{P-P}$ Sine, Inputs AC GND	.39µF		
PSRR	Power Supply Rejection Ratio	$f_{RIPPLE} = 217Hz$ $f_{RIPPLE} = 1kHz$ $f_{RIPPLE} = 15kHz$	83 77 57		dB dB dB
SNR	Signal-to-Noise Ratio	$R_L = 32\Omega$, $P_{OUT} = 8mW$ (A-weighted), $f = 1kHz$ BW = 20Hz to $22kHz$	102		dB
X _{TALK}	Crosstalk	$R_L = 32\Omega$, $P_{OUT} = 5$ mW, $f = 1$ kHz	93		dB

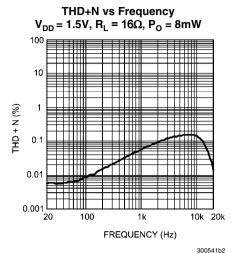
			LM	48861		
Symbo	询"LM48 66/4m供应 商	Conditions	Typical (Note 6)	Limit (Note 7)	Units (Limits)	
N _{OUT}	Output Noise	A-weighted, $A_V = 5.1 dB$ R1 = R2 = $10k\Omega$, R3 = R4 = $18k\Omega$	5		μV	
C-P	Click-Pop	Inputs Grounded BW = <10Hz to >500kHz	79		dB	

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum RatingsRatings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified

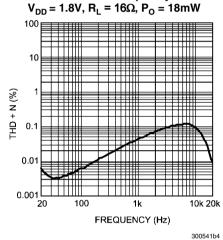
Note 2: The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

- Note 3: Maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} T_A) / \theta_{JA}$ or the number given in Absolute Maximum Ratings, whichever is lower.
- Note 4: Human body model, applicable std. JESD22-A114C.
- Note 5: Machine model, applicable std. JESD22-A115-A.
- Note 6: Typical values represent most likely parametric norms at T_A = +25°C, and at the *Recommended Operation Conditions* at the time of product characterization and are not guaranteed.
- Note 7: Datasheet min/max specification limits are guaranteed by test or statistical analysis.

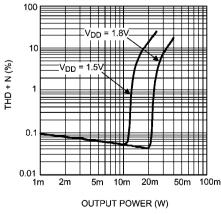
Typical Performance Characteristics 查询"LM48861"供应商



THD+N vs Frequency

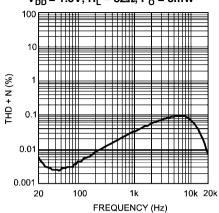


THD+N vs Output Power V_{DD} = 1.5V & 1.8V, R_L = 16 Ω , f = 1kHz



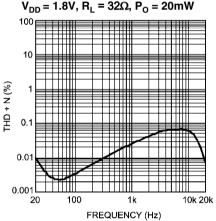
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THD+N vs Frequency $V_{DD} = 1.5V$, $R_L = 32\Omega$, $P_O = 8mW$



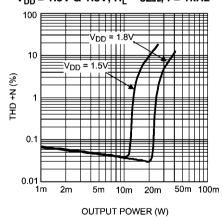
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THD+N vs Frequency



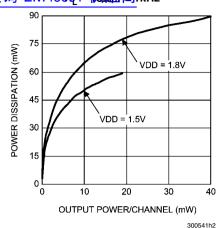
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THD+N vs Output Power V_{DD} = 1.5V & 1.8V, R_L = 32 Ω , f = 1kHz

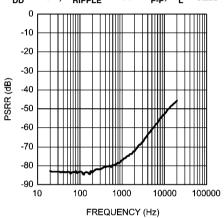


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Power Dissipation vs Output Power 查询"LM48%[="條句"的kHz

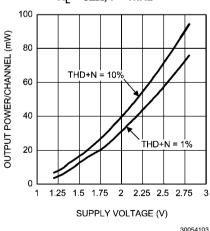


PSRR vs Frequency V_{DD} = 1.5V, V_{RIPPLE} = 200m V_{P-P} , R_L = 32 Ω

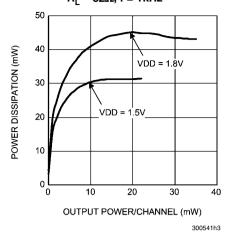


Output Power vs Supply Voltage $R_L = 32\Omega$, f = 1kHz

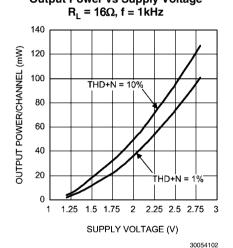
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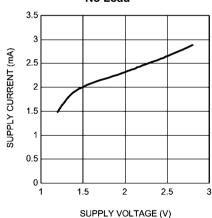
Power Dissipation vs Output Power $R_1 = 32\Omega$, f = 1kHz



Output Power vs Supply Voltage

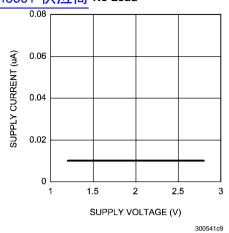


Supply Current vs Supply Voltage No Load

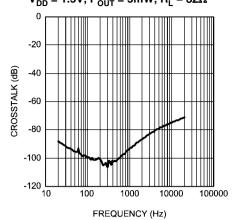


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Shutdown Current vs Supply Voltage 查询"LM48861"供应商 No Load



Crosstalk vs Frequency V_{DD} = 1.5V, P_{OUT} = 5mW, R_{L} = 32 Ω



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Application Information 查询"LM48861"供应商

GENERAL AMPLIFIER FUNCTION

The LM48861 headphone amplifier features National's ground referenced architecture that eliminates the large DC-blocking capacitors required at the outputs of traditional headphone amplifiers. A low-noise inverting charge pump creates a negative supply (CPV $_{SS}$) from the positive supply voltage (V_{DD}). The headphone amplifiers operate from these bipolar supplies, with the amplifier outputs biased about GND, instead of a nominal DC voltage (typically $V_{DD}/2$), like traditional amplifiers. Because there is no DC component to the headphone output signals, the large DC-blocking capacitors (typically 220µF) are not necessary, conserving board space and system cost, while improving frequency response.

COMMON MODE SENSE

The LM48861 features a ground (common mode) sensing feature. In noisy applications, or where the headphone jack is used as a line out to other devices, noise pick up and ground imbalance can degrade audio quality. The LM48861 COM input senses and corrects any noise at the headphone return, or any ground imbalance between the headphone return and device ground, improving audio reproduction. Connect COM directly to the headphone return terminal of the headphone jack (Figure 2). No additional external components are required. Connect COM to GND if the common-mode sense feature is not in use.

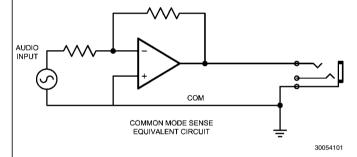


FIGURE 2.

MICRO POWER SHUTDOWN

The voltage applied to the shutdown (\overline{SHDN}) pin controls the LM48861's shutdown function. Activate micro-power shutdown by applying a logic-low voltage to the \overline{SHDN} pin. When active, the LM48861's micro-power shutdown feature turns off the amplifier's bias circuitry, reducing the supply current. The trigger point is 0.4V (max) for a logic-low level, and 1.4V (min) for a logic-high level. The low 0.1µA (typ) shutdown current is achieved by applying a voltage that is as near as ground as possible to the \overline{SHDN} pin. A voltage that is higher than ground may increase the shutdown current.

There are a few ways to control the micro-power shutdown. These include using a single-pole, single-throw switch, a microprocessor, or a microcontroller. When using a switch, connect an external 100k Ω pull-up resistor between the \overline{SHDN} pin and GND. Connect the switch between the \overline{SHDN} pin and VDD. Select normal amplifier operation by closing the switch. Opening the switch connects the \overline{SHDN} pin to ground, activating micro-power shutdown. The switch and resistor guarantee that the \overline{SHDN} pin will not float. This prevents unwanted state changes. In a system with a microprocessor or microcontroller, use a digital output to apply the control

voltage to the SHDN pin. Driving the SHDN pin with active circuitry eliminates the pull-up resistor.

POWER DISSIPATION

Power dissipation is a major concern when using any power amplifier, especially one in mobile devices. In the LM48861, the power dissipation comes from the charge pump and two operational amplifiers. Refer to the Power Dissipation vs Output Power curve in the Typical Performance Characteristics section of the datasheet to find the power dissipation associated the output power level of the LM48861. The power dissipation should not exceed the maximum power dissipation point of the micro SMD package given in equation 1.

$$P_{DMAX} = (T_{JMAX} - T_A) / (\theta_{JA})$$
 (1)

For the LM48861TM micro SMD package, $\theta_{JA} = 70^{\circ}$ C/W. $T_{JMAX} = 150^{\circ}$ C, and T_{A} is the ambient temperature of the system surroundings.

PROPER SELECTION OF EXTERNAL COMPONENTS

Power Supply Bypassing/Filtering

Proper power supply bypassing is critical for low noise performance and high PSRR. Place the supply bypass capacitors as close to the supply pins as possible. Place a $1\mu F$ ceramic capacitor from V_{DD} to GND. Additional bulk capacitance may be added as required.

Charge Pump Capacitor Selection

Use low ESR ceramic capacitors (less than 100m Ω) for optimum performance.

Charge Pump Flying Capacitor (C5)

The flying capacitor (C5) affects the load regulation and output impedance of the charge pump. A C5 value that is too low results in a loss of current drive, leading to a loss of amplifier headroom. A higher valued C5 improves load regulation and lowers charge pump output impedance to an extent. Above $2.2\mu F$, the $R_{\text{DS(ON)}}$ of the charge pump switches and the ESR of C5 and C6 dominate the output impedance. A lower value capacitor can be used in systems with low maximum output power requirements.

Charge Pump Hold Capacitor (C6)

The value and ESR of the hold capacitor (C6) directly affects the ripple on CPV_SS . Increasing the value of C6 reduces output ripple. Decreasing the ESR of C6 reduces both output ripple and charge pump output impedance. A lower value capacitor can be used in systems with low maximum output power requirements.

Power Supply Bypassing /Filtering

Proper power supply bypassing is critical for low noise performance and high PSRR. Place the supply bypass capacitors as close to the device as possible. Typical applications employ a voltage regulator with $10\mu F$ and $0.1\mu F$ bypass capacitors that increase supply stability. These capacitors do not eliminate the need for bypassing of the LM48861 supply pins. A $1\mu F$ capacitor is recommended.

Input Capacitor Selection

9

The LM48861 requires input coupling capacitors. Input capacitors block the DC component of the audio signal, eliminating any conflict between the DC component of the audio source and the bias voltage of the LM48861. The input capacitors create a high-pass filter with the input resistors $R_{\rm IN}$.

The -3dB point of the high-pass filter is found using Equation 查询'<mark>吃你</mark>48861"供应商

$$f = 1 / 2\pi R_{IN} C_{IN}$$
 (2)

Where the value of $R_{\rm IN}$ is selected based on the gain-setting resistor selection. In relation to Figure 1, $R_{\rm IN}$ = R1 = R2, $C_{\rm IN}$ = C1 = C2.

The input capacitors can also be used to remove low frequency content from the audio signal. Small speakers can not reproduce, and may even be damaged by low frequencies. High-pass filtering the audio signal helps protect the speakers. When the LM48861 is using a single-ended source, power supply noise on the ground is seen as an input signal. Setting the high-pass filter point above the power supply noise frequencies, 217Hz in a GSM phone, for example, filters out the noise such that it is not amplified and heard on the output. Capacitors with a tolerance of 10% or better are recommended for impedance matching and improved CMRR and PSRR.

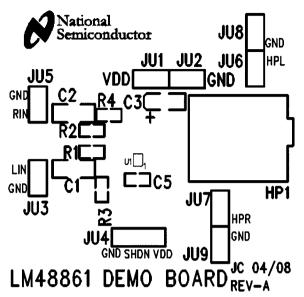
PCB Layout Guidelines

Minimize trace impedance of the power, ground and all output traces for optimum performance. Voltage loss due to trace resistance between the LM48861 and the load results in decreased output power and efficiency. Trace resistance between the power supply and ground has the same effect as a poorly regulated supply, increased ripple and reduced peak output power. Use wide traces for power supply inputs and amplifier outputs to minimize losses due to trace resistance, as well as route heat away from the device. Proper grounding improves audio performance, minimizes crosstalk between channels and prevents switching noise from interfering with the audio signal. Use of power and ground planes is recommended.

As described in the Common Mode Sense section, the LM48861 features a ground sensing feature. On the PCB layout, connect the COM pin (pin D2) directly to the headphone jack ground and also to the left and right input grounds. This will help correct any noise or any ground imbalance between the headphone return, input, and the device ground, therefore improving audio reproduction.

The charge pump capacitors and traces connecting the capacitor to the device should be kept away from the input and output traces to avoid any switching noise injected into the input or output.

Demo Board Schematic and Layout 查询"LM48861"供应商



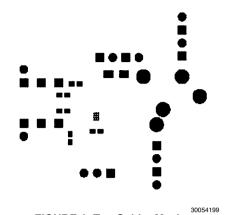


FIGURE 4: Top Solder Mask

FIGURE 3: Top Silkscreen Layer



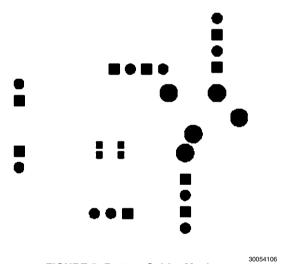


FIGURE 5: Bottom Solder Mask

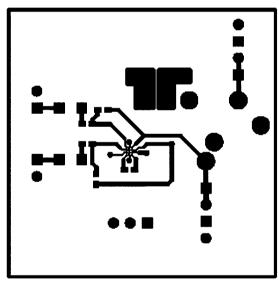


FIGURE 6: Top Layer

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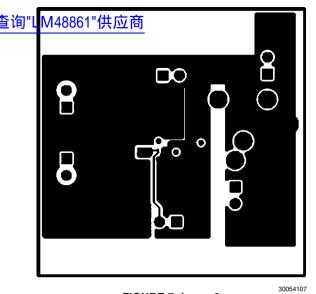


FIGURE 7: Layer 2

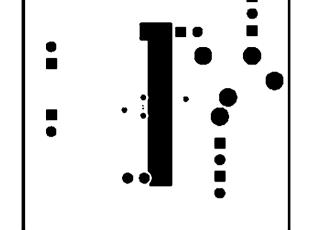


FIGURE 8: Layer 3

30054108

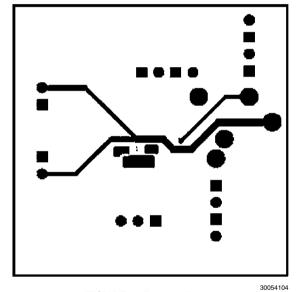


FIGURE 9: Bottom Layer



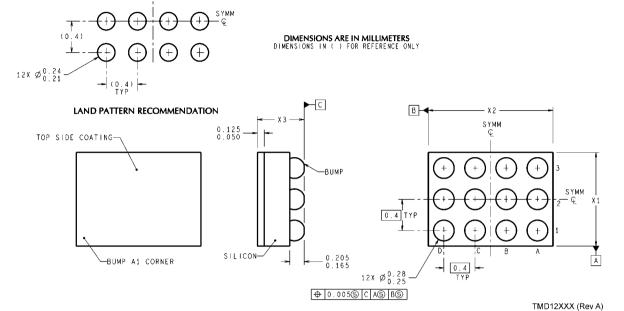
551600087-001 REV-B

FIGURE 10: Bottom Silkscreen

30054105

Revision History 查询"LM48861"供应商

Rev	Date	Description
1.0	06/11/08	Initial release.
1.01	02/08/10	Input text edits.



TM Package
Order Number LM48861TM
NS Package Number TMD12AAA
X1 = 1.215mm, X2 = 1.615mm, X3 = 0.6mm

查询"LM48861"供应商	Notes

≦询"LM48861"供应商

Notes

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Data Converters	www.national.com/adc	Samples	www.national.com/samples	
Interface	www.national.com/interface	Eval Boards	www.national.com/evalboards	
LVDS	www.national.com/lvds	Packaging	www.national.com/packaging	
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green	
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts	
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality	
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback	
Voltage References	www.national.com/vref	Design Made Easy	www.national.com/easy	
PowerWise® Solutions	www.national.com/powerwise	Applications & Markets	www.national.com/solutions	
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero	
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